

Product Texts

LNP THERMOCOMP EC004APQ compound is based on Polyetherimide (PEI) resin containing 20% carbon fiber. Added features of this grade include: Electrically Conductive, FAR25.853 Compliant.

Processing/Physical Characteristics	Value	Unit	Test Standard
ASTM Data			
Mold Shrinkage, MD	0.3	mm/mm	ASTM D 955
Mold Shrinkage, TD	0.55	mm/mm	ASTM D 955

Mechanical properties	Value	Unit	Test Standard
ASTM Data			
Tensile Modulus	19140	MPa	ASTM D 638
Tensile Strength at Break	245	MPa	ASTM D 638
Elongation at Break	2.3	%	ASTM D 638
Flexural Modulus	15800	MPa	ASTM D 790
Izod Impact notched, 1/8 in	109	J/m	ASTM D 256
Izod Impact unnotched, 1/8 in	711	J/m	ASTM D 256

Thermal properties	Value	Unit	Test Standard
ASTM Data			
DTUL @ 264 psi	170	°C	ASTM D 648

Electrical properties	Value	Unit	Test Standard
ASTM Data			
Surface Resistivity	1000000	Ohm	ASTM D 257

Other properties	Value	Unit	Test Standard
Water Absorption, 24hr	0.15	%	ASTM D 570
Density	1330	kg/m ³	ASTM D 792

Processing Recommendation Injection Molding	Value	Unit	Test Standard
Pre-drying - Temperature	150	°C	-
Pre-drying - Time	4 - 6	h	-
Processing humidity	≤0.02	%	-
Melt temperature	360 - 400	°C	-
Mold temperature	140 - 180	°C	-
Zone 1	360 - 380	°C	-
Zone 2	370 - 390	°C	-
Zone 3	380 - 400	°C	-
Back pressure	0.3 - 0.7	MPa	-

Characteristics

Processing

Injection Molding

Special Characteristics

Increased electrical conductivity

Applications

Automotive

Regional Availability

North America, Europe, Asia Pacific